AMENDMENT TRANSMITTAL LETTER (Small Entity) Applicant(s): Steve Nelson						Docket No. 7385-83653	
Serial No. 10/073,462	2/1	ng Date 11/2002	2	Examiner Zarneke, David	Α.		Group Art Unit 2827
Invention: OPTICALLY AT	JUN 1 6 2003 E UATING UNDERC	CHIP ENCAPSUL	ANT				
	TO THE	ASSISTANT COM	MISSION	JER FOR PATE	ENTS	<u></u> -	
최 Small Ent previously 니 A verified	ewith is an amendment in ntity status of this applica ly submitted. d statement to establish n calculated and is trans	ation has been est	tablished u us under 37	under 37 CFR 1			d statement
		CLAIMS A	S AMEND	PED			
	CLAIMS REMAINING	HIGHEST #	NU	JMBER EXTRA		RATE	ADDITIONAL
	AFTER AMENDMENT	PREV. PAID FOR		IMS PRESENT	-		FEE
TOTAL CLAIMS	27 -	27 =		0	+	\$9.00	\$0.00
INDEP. CLAIMS Multiple Depender	4 -	4 =		0	X	\$42.00	\$0.00
Multiple Dependo.	ent Claims (check if appli	licable) TOTAL ADDITION	NAL FEE	FOR THIS AM		MENT	\$0.00 \$0.00
☐ Please change A duplicate ☐ A check in ☑ The Communic Communic A duplicate ☑ Any a	onal fee is required for a narge Deposit Account Narge Deposit Account Nate copy of this sheet is en the amount of missioner is hereby authoration or credit any over the copy of this sheet is eadditional filing fees required application process.	No. enclosed. to cover the horized to charge p rpayment to Depose enclosed. quired under 37 C.F	e filing fee is payment o ssit Accoun	of the following that No. 23-0920	0	associate	d with this 3 feet
Jon P. Christenser Reg. No. 34,137	Signature		Dates.	l certify that am 6/11/2003 first class mail Assistant Cor 20231.	t this o	with er 37 C.F.R. 1 sioner for Pa	and fee is being deposited in the U.S. Postal Service as 1.8 and is addressed to the Patents, Washington, D.C.

CC:

Abby Boone

Typed or Printed Name of Person Mailing Correspondence



83653

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Steve Nelson

Art Unit: 2827

Serial No.:

10/073,462

Filed:

February 11, 2002

For:

OPTICALLY ATTENUATING

UNDERCHIP ENCAPSULANT

Attorney

Docket No.:

83653

AMENDMENT A

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the Office Action of March 12, 2003, please amend the above-identified application as follows:

In the specification:

Amend paragraph [0017] to read as follows:

FIG. 3 illustrates a cut-away side view of a portion of the optical array 44 attached to the optically transparent substrate 52. The optical array 44 may have disposed on a first surface 64 of the substrate 52. Conventional electrical contacts 72 (i.e., solder or stud bumps), and electrical traces (not shown) may be used for electrically connecting the optical array 44 to a signal